

# STP45NF06

# N-channel 60 V, 0.22 Ω typ., 38 A, STripFET™ II Power MOSFET in a TO-220 package

### Datasheet – production data

### Features

Order code	V <sub>DS</sub>	R <sub>DS(on)</sub>	I <sub>D</sub>
STP45NF06	60 V	0.028 Ω	38 A

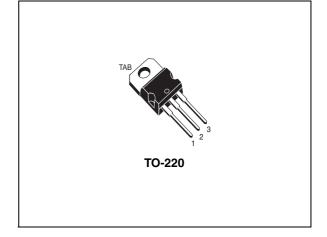
- Typical  $R_{DS(on)} = 0.022 \Omega$
- Exceptional dv/dt capability
- 100% avalanche tested
- Standard threshold drive

## Applications

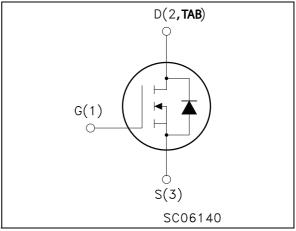
Switching application

### Description

This Power MOSFET has been developed using STMicroelectronics' unique STripFET process, which is specifically designed to minimize input capacitance and gate charge. This renders the device suitable for use as primary switch in advanced high-efficiency isolated DC-DC converters for telecom and computer applications, and applications with low gate charge driving requirements.



#### Figure 1. Internal schematic diagram



#### Table 1. Device summary

Order code	Marking	Package	Packaging
STP45NF06 45NF06		TO-220	Tube

This is information on a product in full production.

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# 1 Electrical ratings

Table 2.	Absolute	maximum	ratings
	Abounde	maximam	radings

Symbol	Parameter	Value	Unit
$V_{DS}$	Drain-source voltage	60	V
V <sub>DGR</sub>	Drain-gate voltage (R <sub>GS</sub> =20 kΩ)	60	V
V <sub>GS</sub>	Gate-source voltage	± 20	V
۱ <sub>D</sub>	Drain current (continuous) at T <sub>C</sub> = 25 °C	38	A
Ι <sub>D</sub>	Drain current (continuous) at T <sub>C</sub> = 100 °C	26	Α
I <sub>DM</sub> <sup>(1)</sup>	Drain current (pulsed)	152	A
P <sub>TOT</sub>	Total dissipation at $T_C = 25 \ ^{\circ}C$	80	W
	Derating factor	0.53	W/°C
dv/dt (2)	Peak diode recovery voltage slope	7	V/ns
T <sub>stg</sub>	Storage temperature	- 65 to 175	°C
Тj	Max. operating junction temperature	175	°C

1. Pulse width limited by safe operating area

2. I\_{SD}  $\,\leq$  38 A, di/dt  $\,\leq$  300 A/µs; V\_{DS(peak)} < V\_{(BR)DSS} , V\_{DD}=80 % V\_{(BR)DSS}

#### Table 3. Thermal data

Symbol	Parameter	Value	Unit
R <sub>thj-case</sub>	Thermal resistance junction-case max	1.88	°C/W
R <sub>thj-amb</sub> <sup>(1)</sup>	Thermal resistance junction-ambient max	35	°C/W

1. When mounted on 1 inch<sup>2</sup> FR-4, 2 Oz copper board.

#### Table 4. Avalanche characteristics

Symbol	Parameter	Value	Unit
I <sub>AR</sub>	Avalanche current, repetetive or not repetetive (pulse width limited by $T_{jmax}$ )	38	А
E <sub>AS</sub>	Single pulse avalanche energy (starting $T_J = 25 \text{ °C}, I_D = I_{AR}; V_{DD} = 50 \text{ V}$ )	135	mJ



# 2 Electrical characteristics

(T<sub>C</sub> = 25 °C unless otherwise specified).

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>(BR)DSS</sub>	Drain-source breakdown voltage	I <sub>D</sub> = 250 mA, V <sub>GS</sub> = 0	60			V
I <sub>DSS</sub>	Zero gate voltage drain current (V <sub>GS</sub> = 0)	V <sub>DS</sub> = 60 V V <sub>DS</sub> = 60 V, T <sub>C</sub> =125 °C			1 10	μΑ μΑ
I <sub>GSS</sub>	Gate-body leakage current (V <sub>DS</sub> = 0)	V <sub>GS</sub> = ± 20 V			± 100	nA
V <sub>GS(th)</sub>	Gate threshold voltage	$V_{DS} = V_{GS}$ , $I_D = 250 \ \mu A$	2	3	4	V
R <sub>DS(on)</sub>	Static drain-source on- resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 19 A		0.022	0.028	Ω

#### Table 5. On /off states

### Table 6. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
${g_{fs}}^{(1)}$	Forward trasconductance	$V_{DS}>I_{D(on)}*R_{DS(on)max}, I_{D}=19 \text{ A}$	-	24		S
C <sub>iss</sub> C <sub>oss</sub> C <sub>rss</sub>	Input capacitance Output capacitance Reverse transfer capacitance	V <sub>DS</sub> = 25 V, f = 1 MHz, V <sub>GS</sub> = 0	-	1730 215 63		pF pF pF
Q <sub>g</sub> Q <sub>gs</sub> Q <sub>gs</sub>	Total gate charge Gate-source charge Gate-drain charge	V <sub>DD</sub> = 48 V, I <sub>D</sub> = 38 A, V <sub>GS</sub> = 10 V	-	43 9 15	58	ns ns ns

1. Pulsed: pulse duration = 300  $\mu$ s, duty cycle 1.5%

Table 7. Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t <sub>d(on)</sub> t <sub>r</sub>	Turn-on delay time Voltage rise time	$V_{DD} = 30$ V, $I_D = 19$ A, R <sub>G</sub> = 4.7 Ω, V <sub>GS</sub> = 10 V	-	20 100	-	ns ns
t <sub>d(off)</sub> t <sub>f</sub>	Turn-off delay time Fall time	(see <i>Figure 14</i> )	-	50 20	-	ns ns
t <sub>d(off)</sub> t <sub>f</sub> t <sub>c</sub>	Off-voltage rise time Fall time Cross-over time	$V_{clamp} = 48 \text{ V}, I_D = 38 \text{ A},$ $R_G = 4.7 \Omega, V_{GS} = 10 \text{ V}$ (see <i>Figure 16</i> )	-	45 42 60	-	ns ns ns



Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I <sub>SD</sub> I <sub>SDM</sub> <sup>(1)</sup>	Source-drain current Source-drain current (pulsed)		-		38 152	A A
V <sub>SD</sub> <sup>(2)</sup>	Forward on voltage	I <sub>SD</sub> = 38 A, V <sub>GS</sub> = 0	-		1.5	V
t <sub>rr</sub> Q <sub>rr</sub> I <sub>RRM</sub>	Reverse recovery time Reverse recovery charge Reverse recovery current	$I_{SD} = 38 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}$ $V_{DD} = 100 \text{ V}, \text{ T}_{j} = 150 ^{\circ}\text{C}$ (see <i>Figure 16</i> )	-	95 260 5.5		ns µC A

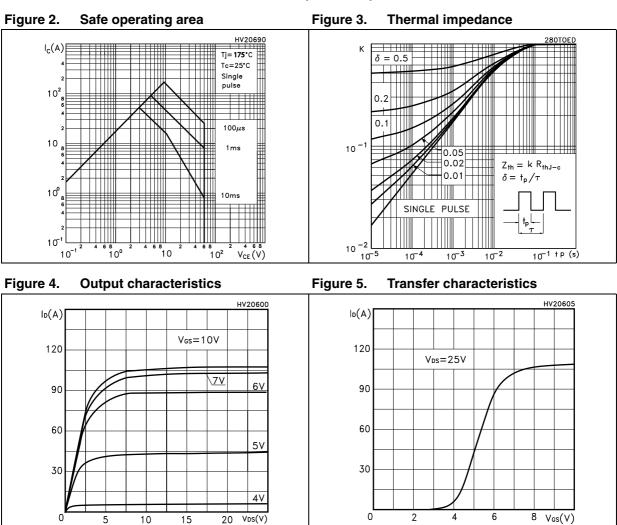
 Table 8.
 Source drain diode

1. Pulsed: pulse duration =  $300 \ \mu$ s, duty cycle 1.5%

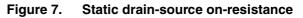
2. Pulse width limited by safe operating area.

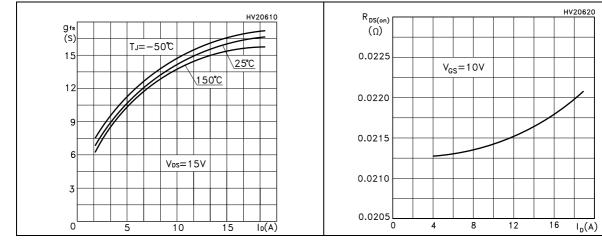


## 2.1 Electrical characteristics (curves)

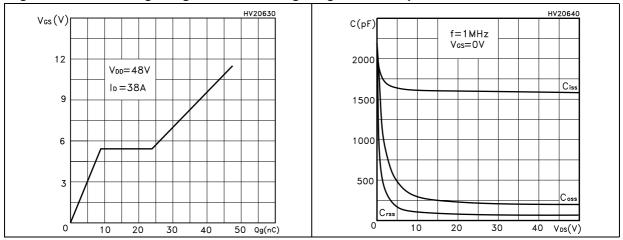


#### Figure 6. Transconductance









#### Figure 8. Gate charge vs gate-source voltage Figure 9. Capacitance variations

Figure 10. Normalized gate threshold voltage Figure 11. Normalized on-resistance vs vs temperature temperature

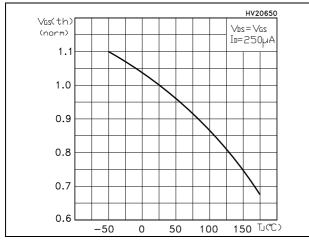
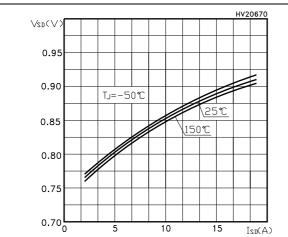


Figure 12. Source-drain diode forward characteristics



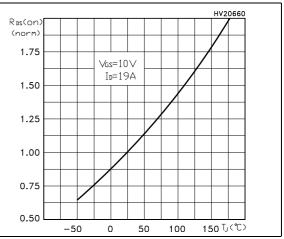
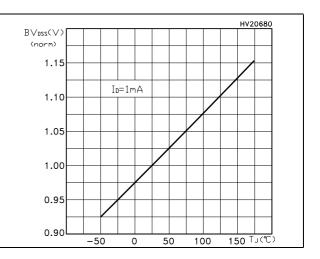


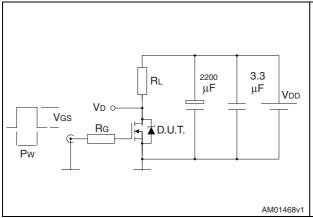
Figure 13. Normalized B<sub>VDSS</sub> vs temperature



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## 3 Test circuits

Figure 14. Switching times test circuit for resistive load



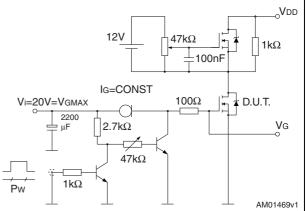
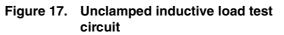


Figure 16. Test circuit for inductive load switching and diode recovery times



J

D.U.T.

2200

μF

\_

3.3

μF

Vdd

AM01471v1

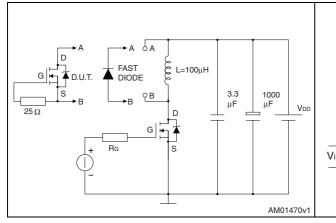




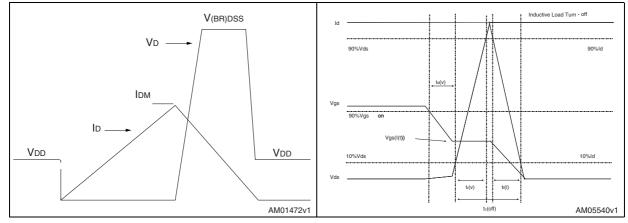
Figure 19. Switching time waveform

VD O

lр

Pw

0



### Figure 15. Gate charge test circuit



# 4 Package mechanical data

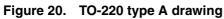
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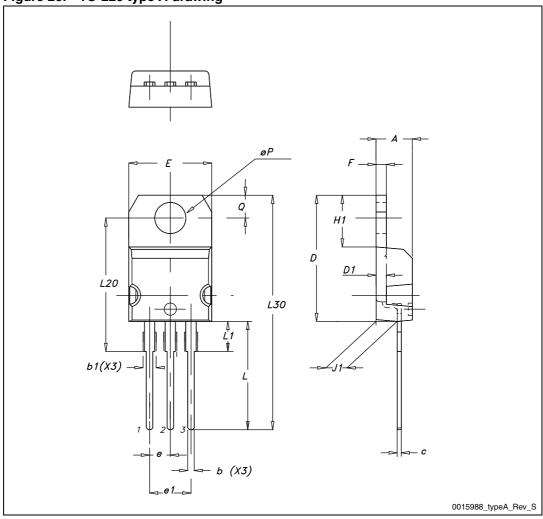


Table 9.	TO-220 type A mechanical data

Dim.	mm		
	Min.	Тур.	Max.
Α	4.40		4.60
b	0.61		0.88
b1	1.14		1.70
с	0.48		0.70
D	15.25		15.75
D1		1.27	
E	10		10.40
е	2.40		2.70
e1	4.95		5.15
F	1.23		1.32
H1	6.20		6.60
J1	2.40		2.72
L	13		14
L1	3.50		3.93
L20		16.40	
L30		28.90	
ØР	3.75		3.85
Q	2.65		2.95









# 5 Revision history

Date	Revision	Changes
09-Sep-2004	1	Preliminary version.
04-Feb-2005	2	Complete version.
17-Aug-2006	3	New template. No content change.
13-Nov-2006	4	Inserted new value.
05-Jul-2010	5	Updated Section 2.1: Electrical characteristics (curves).
19-Dec-2012	6	Updated: Section 4: Package mechanical data



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